

FEATURES

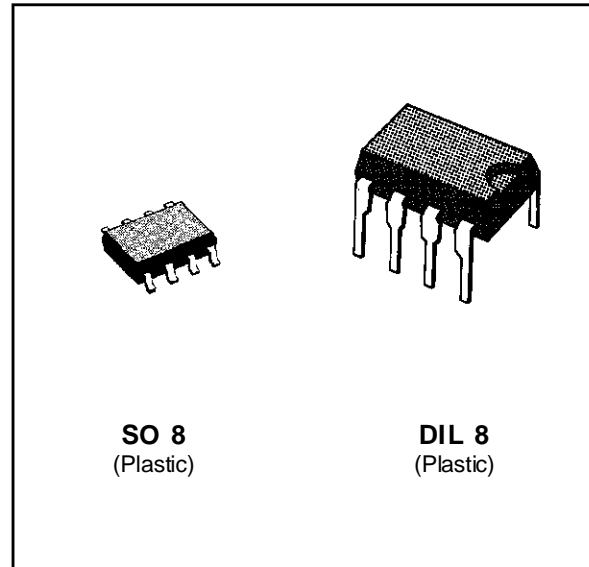
- BIDIRECTIONAL TRIPLE PROTECTION
- CROWBAR PROTECTION
- PEAK PULSE CURRENT :
 $I_{PP} = 30 \text{ A}, 10/1000 \mu\text{s}$
- HOLDING CURRENT = 150 mA min
- AVAILABLE IN DIP 8 AND SO 8 PACKAGES

DESCRIPTION

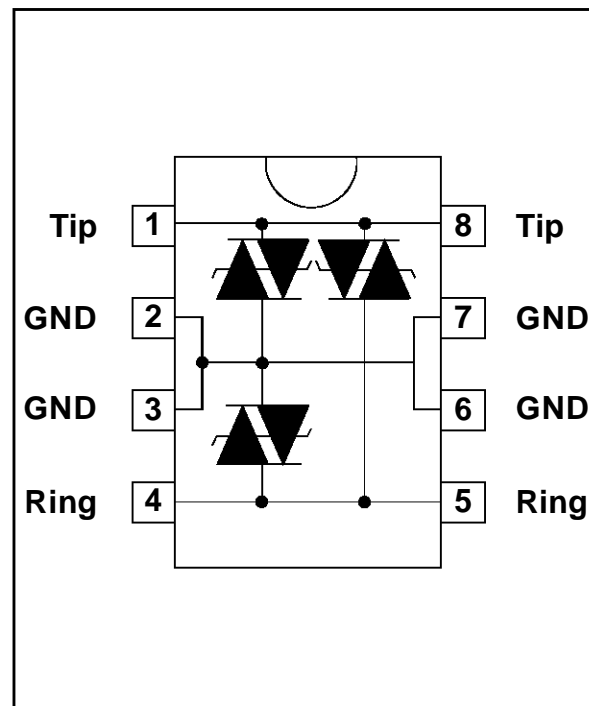
Dedicated to telecommunication equipment protection, these devices provide a triple bidirectional protection function.

They ensure the same protection capability with the same breakdown voltage both in common mode and in differential mode.

Particular attention has been given to the internal wire bonding . A 4-point configuration ensures reliable protection, eliminating the overvoltage introduced by the parasitic inductances of the wiring (Ldi/dt) especially for very fast transients.



SCHEMATIC DIAGRAM



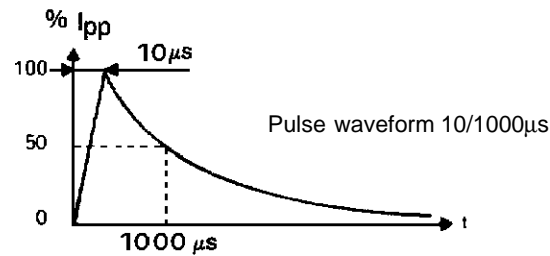
IN ACCORDANCE WITH FOLLOWING STANDARDS :

CCITT K17 - K20	{	10/700 μs	1.5 kV
		5/310 μs	38 A
VDE 0433	{	10/700 μs	2 kV
		5/200 μs	50 A
CNET	{	0.5/700 μs	1.5 kV
		0.2/310 μs	38 A

THBT150 / THBT200 / THBT270

ABSOLUTE RATINGS (limiting values) ($-40^{\circ}\text{C} \leq T_{\text{amb}} \leq +85^{\circ}\text{C}$)

Symbol	Parameter		Value	Unit
I_{PP}	Peak pulse current	10/1000 μs 5/320 μs 2/10 μs	30 40 75	A
I_{TSM}	Non repetitive surge peak on-state current	$t_{\text{p}} = 10 \text{ ms}$ $t_{\text{p}} = 1 \text{ s}$	5 3.5	A
di/dt	Critical rate of rise of on-state current	Non repetitive	100	A/ μs
dv/dt	Critical rate of rise of off-state voltage	67% V_{BR}	5	KV/ μs
T_{stg} T_{j}	Storage and operating junction temperature range		- 40 to + 150 + 150	$^{\circ}\text{C}$ $^{\circ}\text{C}$

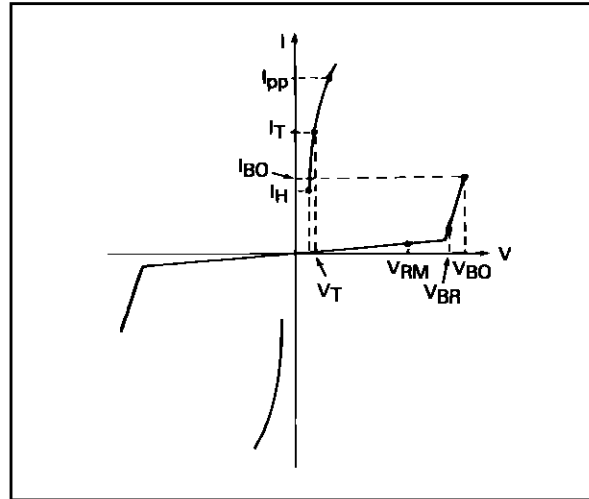


THERMAL RESISTANCES

Symbol	Parameter		Value	Unit
$R_{\text{th}}(j-a)$	Junction-to-ambient	DIL 8 SO 8	125 171	$^{\circ}\text{C}/\text{W}$ $^{\circ}\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Symbol	Parameter
V_{RM}	Stand-off voltage
V_{BR}	Breakdown voltage
V_{BO}	Breakover voltage
I_H	Holding current
V_T	On-state voltage
I_{BO}	Breakover current
I_{PP}	Peak pulse current



STATIC PARAMETERS

Types	I_R @ V_{RM}		V_{BR} @ I_R		V_{BO} @ I_{BO}			I_H	V_T	C
	max		min		max	min		min	max	max
	μA	V	V	mA	V	mA	mA	mA	V	pF
THBT150	5	135	150	1	210	50	400	150	8	200
THBT200	5	180	200	1	290	50	400	150	8	200
THBT270	5	240	270	1	380	50	400	150	8	200

DYNAMIC PARAMETERS

Types	V_{BO} dyn Typical Value
	note 4 (V)
THBT150	290
THBT200	380
THBT270	420

All parameters tested at 25°C, except where indicated

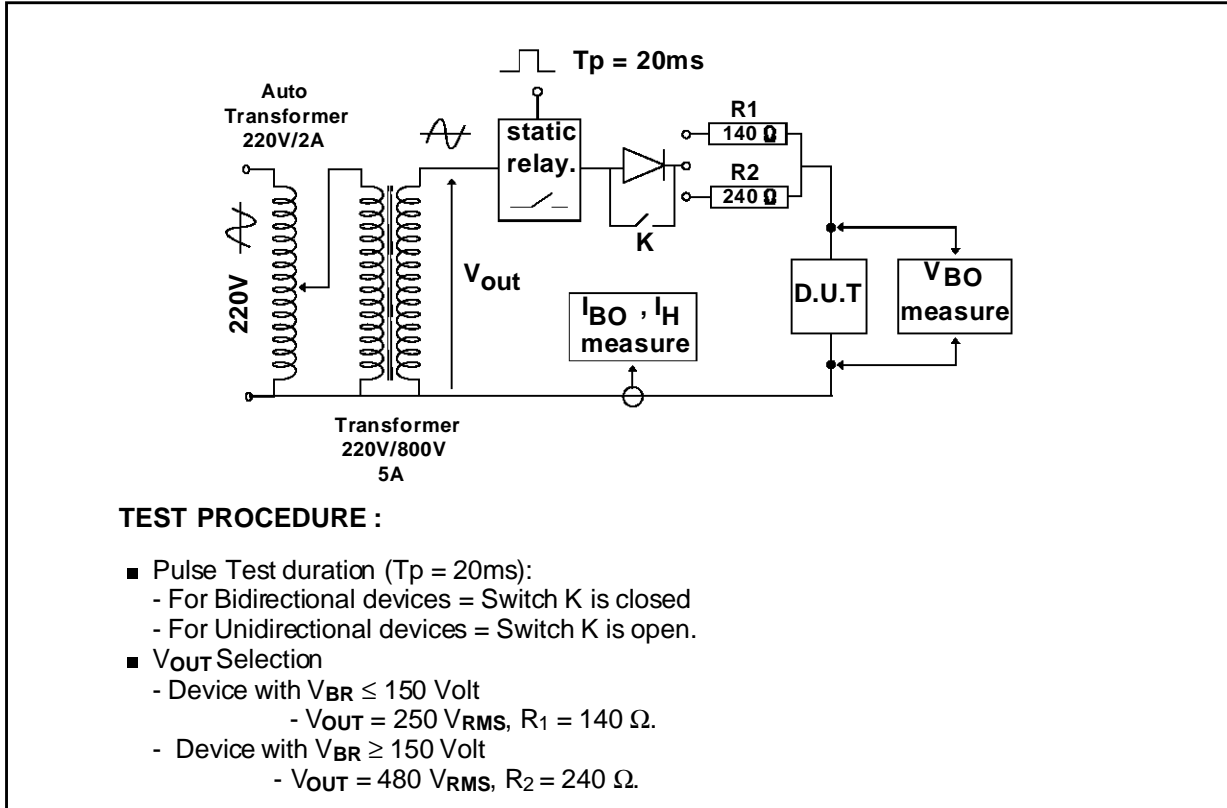
Note 1 : See the reference test circuit for I_H , I_{BO} and V_{BO} parameters.

Note 2 : Square pulse $T_p = 500 \mu s$ - $I_T = 5A$.

Note 3 : $V_R = 1V$, $F = 1MHz$.

Note 4 : The dynamic breakover voltage is measured with following surge test : CCITT - 1.5 KV 10/700 μs

REFERENCE TEST CIRCUIT FOR I_H , I_{BO} and V_{BO} parameters :



FUNCTIONAL HOLDING CURRENT (I_H) TEST CIRCUIT = GO - NOGO TEST

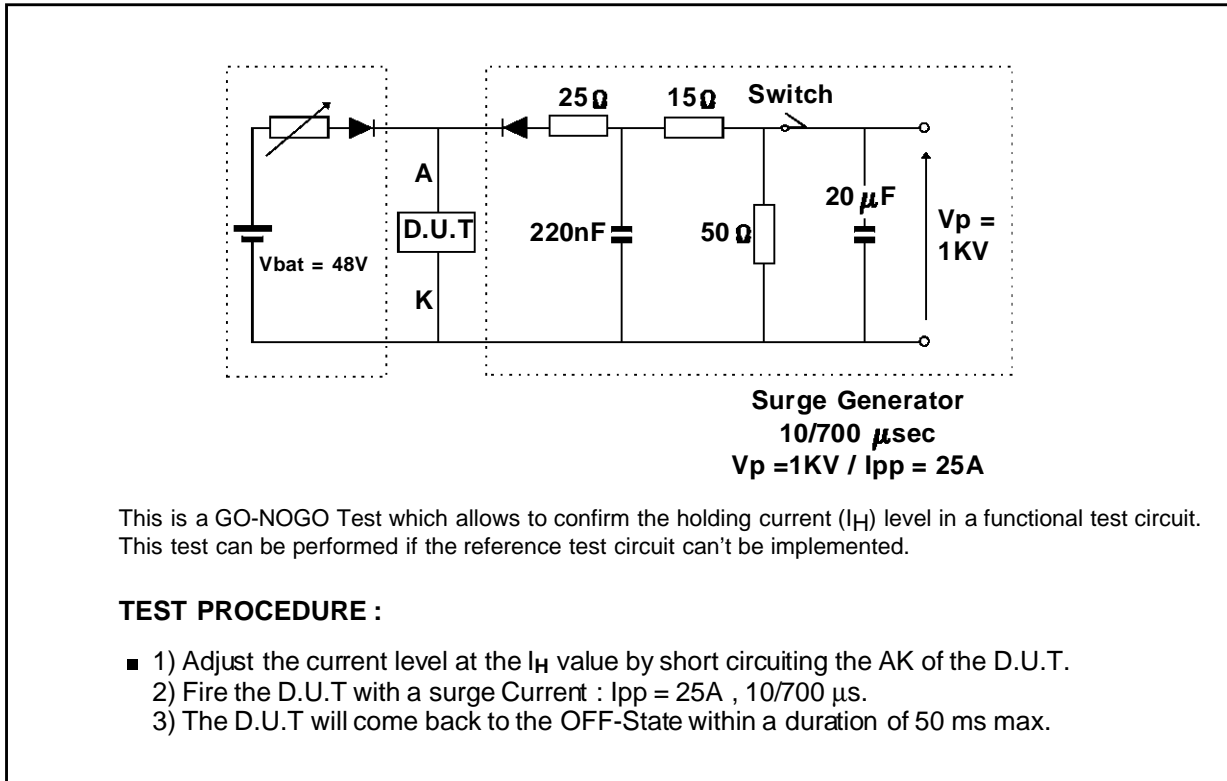
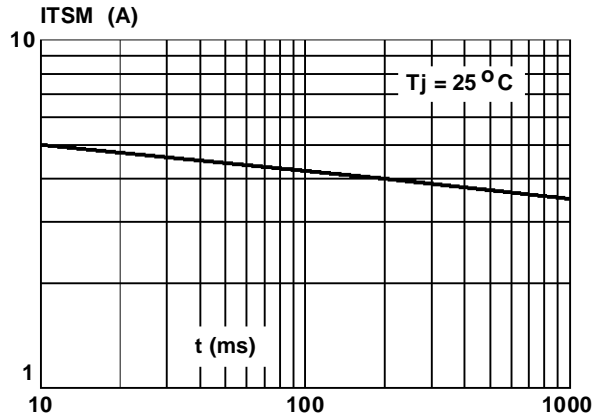


Figure 1 : Non repetitive surge peak on-state current. (with sinusoidal pulse : F =50Hz)



APPLICATION NOTE

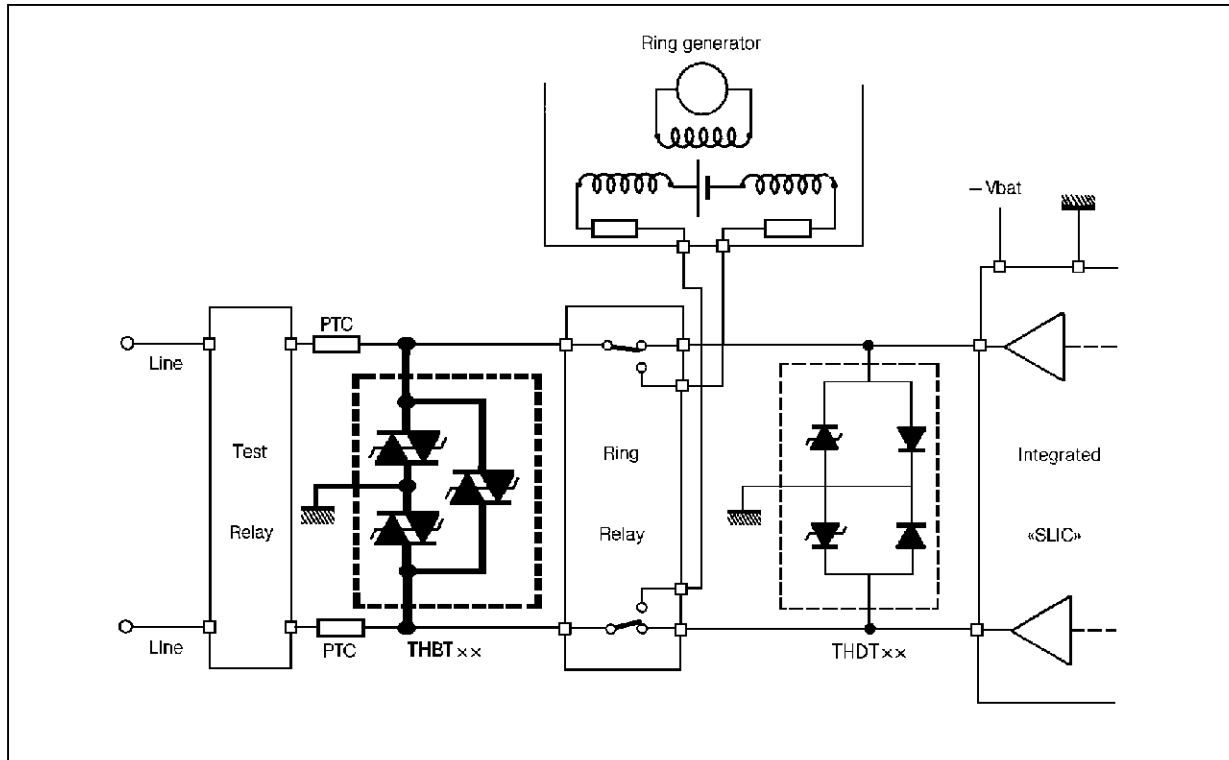
4- points structure lay-out.

- 1) Connect pins 2, 3, 6 and 7 to ground in order to guarantee a good surge current capability for long duration disturbances.

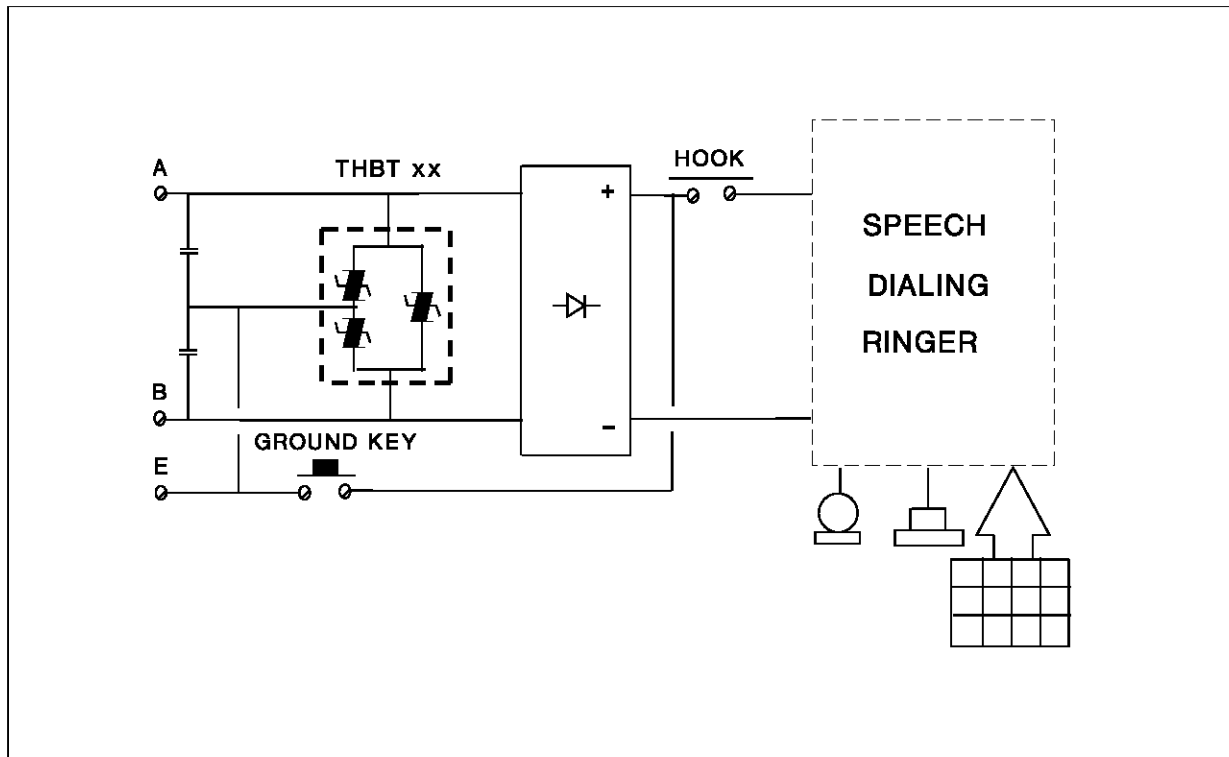
- 2) In order to take advantage of the "4-points structure" of the THBTxxx, the tip and Ring lines have to cross through the device. In this case, the device will eliminate the overvoltages generated by the parasitic inductances of the wiring (Ldi/dt), especially for very fast Transients.

APPLICATION CIRCUIT

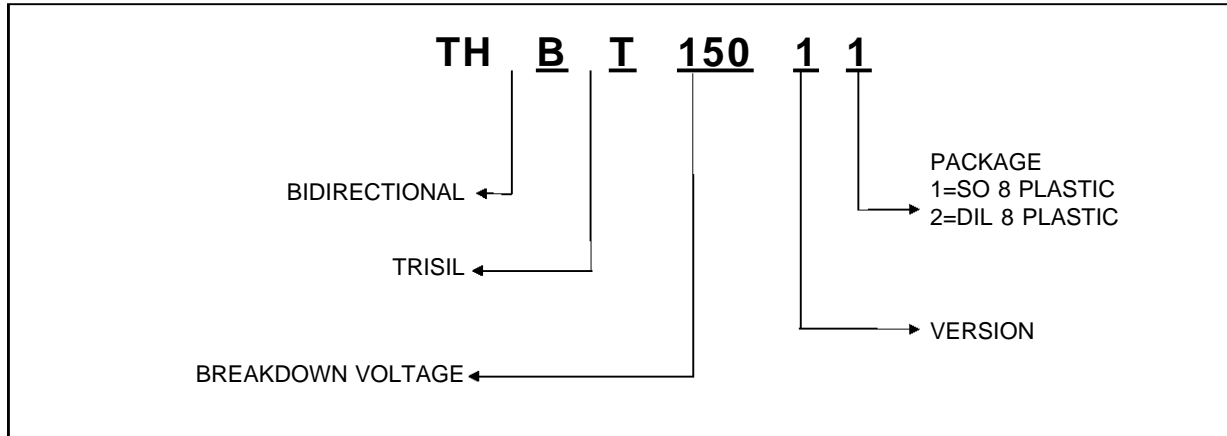
Line card protection



Ground key telephone set protection



ORDER CODE



MARKING

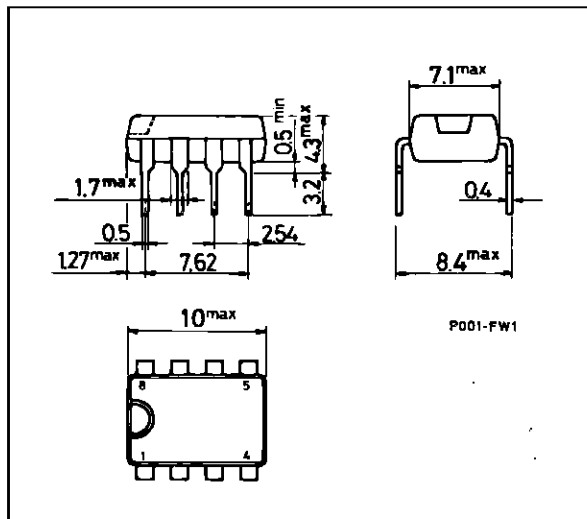
Package	Type	Marking
SO8	THBT15011	BT1511
	THBT20011	BT2011
	THBT27011	BT2711

Package	Type	Marking
DIL8	THBT15012	BT1512
	THBT20012	BT2012
	THBT27012	BT2712

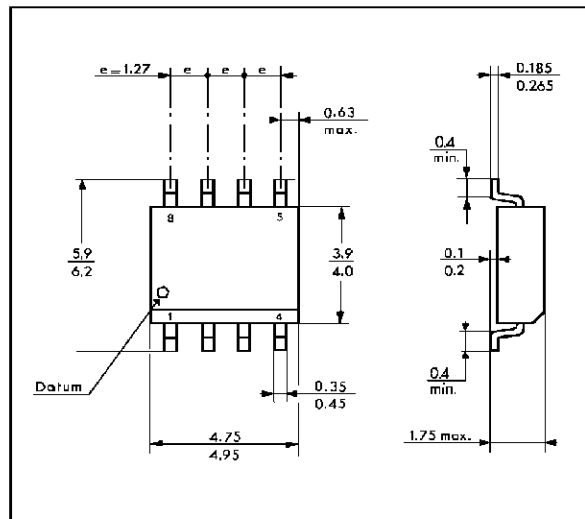
Packaging : Products supplied in antistatic tubes.

PACKAGE MECHANICAL DATA (in millimeters)

DIL 8 Plastic



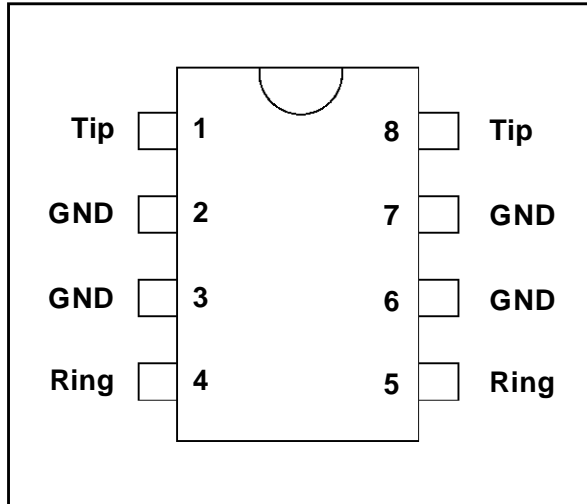
SO 8 Plastic



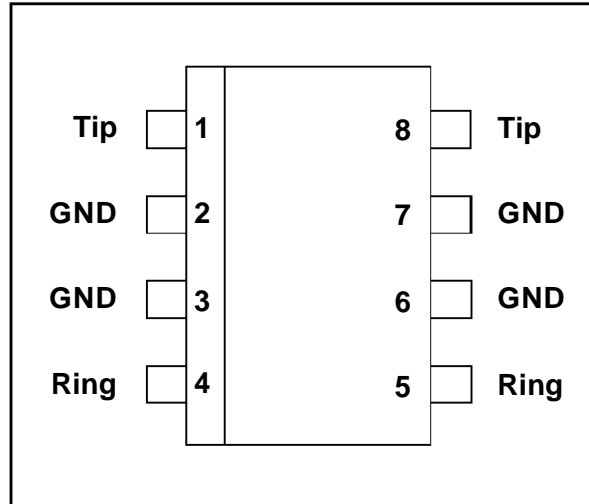
THBT150 / THBT200 / THBT270

CONNECTION DIAGRAM

DIL 8 Plastic



SO 8 Plastic



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